

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5832023

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
VIA TECHNOLOGIES, INC.		10/22/2019
RECEIVING PARTY DATA		
Name:	VIA LABS, INC.	
Street Address:	7F, 529-1, ZHONGZHENG RD., XINDIAN DIST.	
City:	NEW TAIPEI CITY	
State/Country:	TAIWAN	
Postal Code:	231	
PROPERTY NUMBERS Total: 28		
Property Type	Number	
Patent Number:	7996586	
Patent Number:	8737450	
Patent Number:	8446921	
Patent Number:	8499186	
Patent Number:	9158329	
Patent Number:	9048098	
Patent Number:	9111752	
Patent Number:	8799688	
Patent Number:	8769317	
Patent Number:	8894297	
Patent Number:	9110143	
Patent Number:	9112370	
Patent Number:	9239609	
Patent Number:	9142541	
Patent Number:	9583555	
Patent Number:	9606597	
Patent Number:	10318463	
Patent Number:	10211924	
Patent Number:	9772653	
Patent Number:	9350407	

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Property Type	Number
Patent Number:	10153759
Patent Number:	9443842
Patent Number:	9443843
Patent Number:	10061735
Application Number:	16050103
Patent Number:	9991327
Patent Number:	10103217
Patent Number:	10041999

CORRESPONDENCE DATA

Fax Number: (404)521-4286

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER: 252210-9010

NAME OF SUBMITTER: DANIEL R. MCCLURE

SIGNATURE: /Daniel R. McClure/

DATE SIGNED: 11/21/2019

Total Attachments: 2

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DEED OF ASSIGNMENT

WHEREAS, VIA TECHNOLOGIES, INC., having a place of business at 8F, 533, Zhongzheng Rd., Xindian Dist., New Taipei City 231, Taiwan, hereinafter referred to as ASSIGNOR, owns all right, title, and interest in the following U. S. patents/patent application:

No.	Application Number	Filing or 371 (c) Date	Patent Number	Assignor's Ref.
1	12/509,079	July 24, 2009	7,996,586	VIT09-0015I00-US
2	12/550,475	August 31, 2009	8,737,450	VIT09-0017I00-US
3	12/776,530	May 10, 2010	8,446,921	VIT09-0048I00-US
4	12/776,523	May 10, 2010	8,499,186	VIT09-0050I00-US
5	13/935,860	July 5, 2013	9,158,329	VIT09-0050I01-US
6	13/666,509	November 1, 2012	9,048,098	VIT11-0017I00-US
7	14/696,785	April 27, 2015	9,111,752	VIT11-0017I01-US
8	13/473,052	May 16, 2012	8,799,688	VIT11-0024I00-US
9	13/354,895	January 20, 2012	8,769,317	VIT11-0029I00-US
10	13/588,558	April 17, 2012	8,894,297	VIT11-0038I00-US
11	13/744,982	January 18, 2013	9,110,143	VIT12-0005I00-US
12	13/744,908	January 13, 2013	9,112,370	VIT12-0017I00-US
13	14/057,277	October 18, 2013	9,239,609	VIT13-0009I00-US
14	14/076,419	November 11, 2013	9,142,541	VIT13-0010I00-US
15	14/813,510	July 30, 2015	9,583,555	VIT13-0010I01-US
16	14/205,790	March 12, 2014	9,606,597	VIT13-0017I00-US
17	14/452,784	August 6, 2014	10,318,463	VIT13-0042I00-US
18	14/592,198	January 8, 2015	10,211,924	VIT14-0010I00-US
19	14/692,155	April 21, 2015	9,772,653	VIT14-0017I00-US
20	14/837,412	August 27, 2015	9,350,407	VIT14-0039I00-US
21	14/877,509	October 7, 2015	10,153,759	VIT14-0040I00-US
22	14/926,851	October 29, 2015	9,443,842	VIT15-0004I00-US
23	14/926,868	October 29, 2015	9,443,843	VIT15-0004I01-US

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24	15/059,227	March 2, 2016	10,061,735	VIT15-0007I00-US
25	16/050,103	July 31, 2018		VIT15-0007I01-US
26	15/440,082	February 23, 2017	9,991,327	VIT16-0019I00-US
27	15/971,218	May 4, 2018	10,103,217	VIT16-0019I01-US
28	15/411,063	January 20, 2017	10,041,999	VIT16-0026I00-US

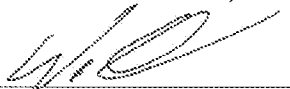
WHEREAS, VIA LABS, INC., having a place of business at 7F, 529-1, Zhongzheng Rd., Xindian Dist., New Taipei City 231, Taiwan, hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in and to said U.S. patents and any provisional, continuation, continuation-in-part, divisional, reissued, and re-examined patents/patent applications relating to said U.S. patents.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged by ASSIGNOR, ASSIGNOR has sold, assigned and transferred and does hereby sell, assign and transfer unto ASSIGNEE, and ASSIGNEE'S successors and assigns, (a) the entire right, title and interest, for the United States of America, in and to said U.S. patents and all the rights and privileges in any application and under any and all patents that may be granted in the U.S. for any invention(s) described in said patents, including but not limited to, all corresponding provisional, continuation, continuation-in-part, divisional, reissue, and reexamination applications; and (b) the entire right, title and interest in and to any and all foreign patents and applications for any invention described in said U.S. patents, in any and all countries foreign to the U.S., including all rights of priority arising from them, and all the rights and privileges under any and all forms of protection, including patents, that may be granted in said countries foreign to the U.S. for them; and (c) the right to seek remedies for any and all infringements of any of the foregoing patents and to collect and retain all damages and profits and enjoy any and all remedies granted for infringements.

ASSIGNOR authorizes ASSIGNEE to make any and all application for such protection in its own name and maintain such protection in any and all countries foreign to the U.S., and to invoke and claim for any application for patent or other form of protection for any said invention, without further authorization from ASSIGNOR, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

Assignor: VIA TECHNOLOGIES, INC.

By:



Date:

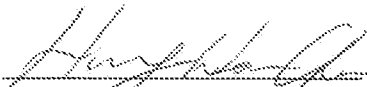
2019. 10. 22

Name: Wen-Chi CHEN

Title: Chairman

Assignee: VIA LABS, INC.

By:



Date:

2019. 10. 22

Name: Hung-wen, CHEN

Title: Vice President

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PATENT

RECORDED: 11/21/2019

REEL: 051075 FRAME: 0261